

AMENDMENTS TO THE SPECIFICATION

Please amend the paragraph beginning on page 8, line 17 as follows:

-- Turning first to Figs 1 and 4, there is shown a first exemplary embodiment of the present invention. A substrate 1 is at step 100 transferred to a screen printer 12 where an initial application of solder paste is performed, at step 102. Then, the substrate 1 is transferred at step 104 to a machine 16 for performing add-on jetting of additional amounts of solder paste, at step 106. The amounts, patterns, heights, type of solder paste, etc., that is added onto the substrate 1 is predetermined. Thus, there is no inspection [[if]] of the screen printing results performed prior to the jetting of additional solder paste. Following the add-on jetting step, the substrate 1 is at step 108 transferred to a component mounting machine 18, where electrical components are mounted on the substrate 1. As an alternative, there may be included a step of inspecting the final results of the combined solder paste application, i.e. both the screen printing and the add-on jetting. --